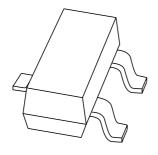
DISCRETE SEMICONDUCTORS

DATA SHEET



PBSS4350T50 V; 3 A NPN low V_{CEsat} (BISS) transistor

Product specification Supersedes data of 2002 Aug 08 2004 Jan 09





50 V; 3 A NPN low V_{CEsat} (BISS) transistor

PBSS4350T

FEATURES

- Low collector-emitter saturation voltage V_{CEsat} and corresponding low R_{CEsat}
- · High collector current capability
- · High collector current gain
- Improved efficiency due to reduced heat generation.

APPLICATIONS

- · Power management applications
- Low and medium power DC/DC convertors
- · Supply line switching
- · Battery chargers
- Linear voltage regulation with low voltage drop-out (LDO).

DESCRIPTION

NPN low V_{CEsat} transistor in a SOT23 plastic package. PNP complement: PBSS5350T.

MARKING

TYPE NUMBER	MARKING CODE(1)
PBSS4350T	ZC*

Note

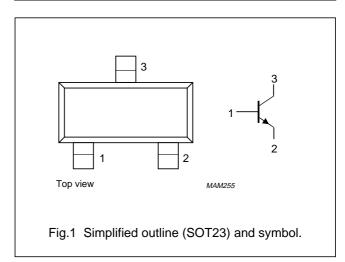
- 1. * = p: Made in Hong Kong.
 - * = t: Made in Malaysia.
 - * = W: Made in China.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	50	V
I _C	collector current (DC)	2	Α
I _{CRP}	repetitive peak collector current		А
R _{CEsat}	equivalent on-resistance		mΩ

PINNING

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	



ORDERING INFORMATION

TYPE	PACKAGE			
NUMBER	NAME DESCRIPTION VERSION			
PBSS4350T	_	plastic surface mounted package; 3 leads SO		

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	PARAMETER CONDITIONS		MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	50	V
V _{CEO}	collector-emitter voltage	open base	_	50	V
V _{EBO}	emitter-base voltage	open collector	_	5	V
I _C	collector current (DC)		_	2	А
I _{CRP}	repetitive peak collector current	note 1	_	3	А
I _{CM}	peak collector current	single peak	_	5	Α
I _B	base current (DC)		_	0.5	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 2	_	300	mW
		T _{amb} ≤ 25 °C; note 3	_	480	mW
		T _{amb} ≤ 25 °C; note 4	_	540	mW
		T _{amb} ≤ 25 °C; notes 1 and 2	_	1.2	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Operated under pulsed conditions: pulse width $t_p \le 100$ ms; duty cycle $\delta \le 0.25$.
- 2. Device mounted on a printed-circuit board; single sided copper; tinplated; standard footprint.
- 3. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm².
- 4. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 6 cm².

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to	in free air; note 1	417	K/W
	ambient	in free air; note 2	260	K/W
		in free air; note 3	230	K/W
		in free air; notes 1 and 4	104	K/W

Notes

- 1. Device mounted on a printed-circuit board; single sided copper; tinplated; standard footprint.
- 2. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm².
- 3. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 6 cm².
- 4. Operated under pulsed conditions: pulse width $t_p \leq 100$ ms; duty cycle $\delta \leq 0.25.$

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

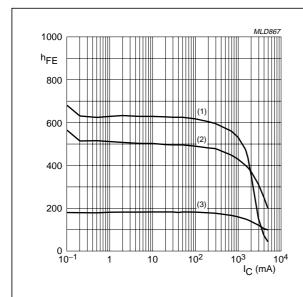
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	I _E = 0; V _{CB} = 50 V	_	_	100	nA
		I _E = 0; V _{CB} = 50 V; T _j = 150 °C	-	_	50	μΑ
I _{EBO}	emitter-base cut-off current	I _C = 0; V _{EB} = 5 V	_	_	100	nA
h _{FE}	DC current gain	I _C = 100 mA; V _{CE} = 2 V	300	_	_	
		I _C = 500 mA; V _{CE} = 2 V	300	_	_	
		I _C = 1 A; V _{CE} = 2 V; note 1	300	_	_	
		I _C = 2 A; V _{CE} = 2 V; note 1	200	_	_	
		I _C = 3 A; V _{CE} = 2 V; note 1	100	_	_	
V _{CEsat}	collector-emitter saturation voltage	I _C = 500 mA; I _B = 50 mA	_	_	80	mV
		I _C = 1 A; I _B = 50 mA	-	_	160	mV
		I _C = 2 A; I _B = 100 mA; note 1	_	_	280	mV
		I _C = 2 A; I _B = 200 mA; note 1	_	_	260	mV
		I _C = 3 A; I _B = 300 mA; note 1	-	_	370	mV
R _{CEsat}	equivalent on-resistance	I _C = 2 A; I _B = 200 mA; note 1	_	100	130	mΩ
V _{BEsat}	base-emitter saturation	I _C = 2 A; I _B = 100 mA; note 1	_	_	1.1	V
	voltage	I _C = 3 A; I _B = 300 mA; note 1	_	_	1.2	V
V _{BEon}	base-emitter turn-on voltage	I _C = 1 A; V _{CE} = 2 V; note 1	1.2	_	_	V
f _T	transition frequency	I _C = 100 mA; V _{CE} = 5 V; f = 100 MHz	100	_	_	MHz
C _c	collector capacitance	I _E = I _e = 0; V _{CB} = 10 V; f = 1 MHz	_	_	25	pF

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

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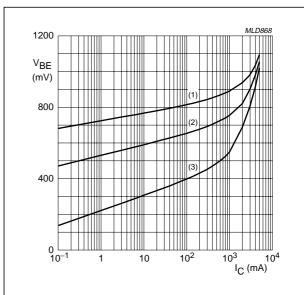
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 $V_{CE} = 2 V$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

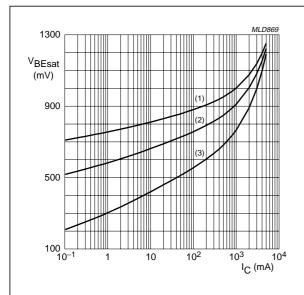
Fig.2 DC current gain as a function of collector current; typical values.



V_{CE} = 2 V.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

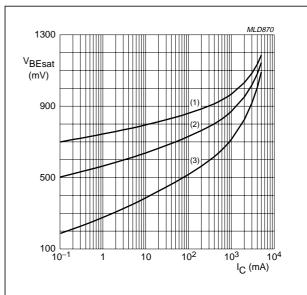
Fig.3 Base-emitter voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 10.$

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

Fig.4 Base-emitter saturation voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B}=20$.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

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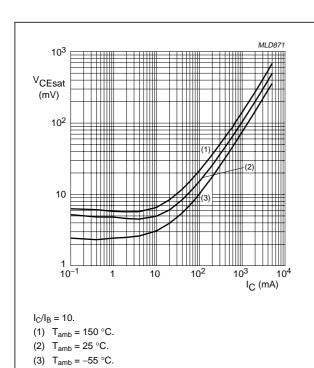
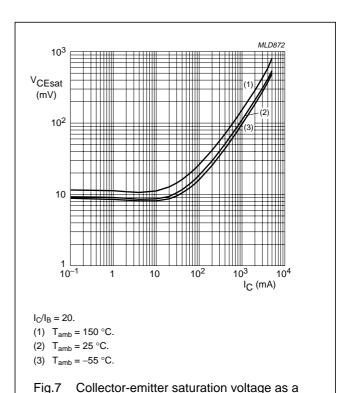
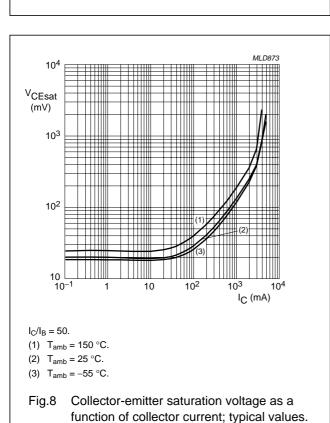
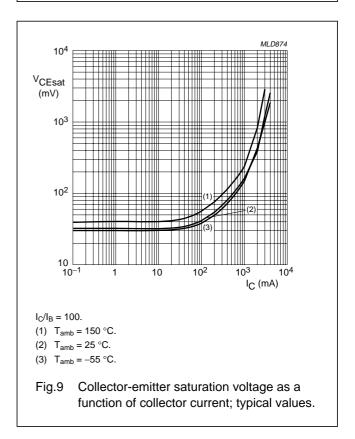


Fig.6 Collector-emitter saturation voltage as a function of collector current; typical values.



function of collector current; typical values.





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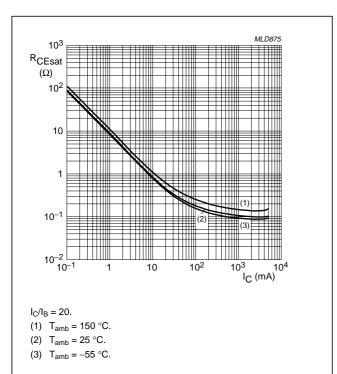


Fig.10 Equivalent on-resistance as a function of collector current; typical values.

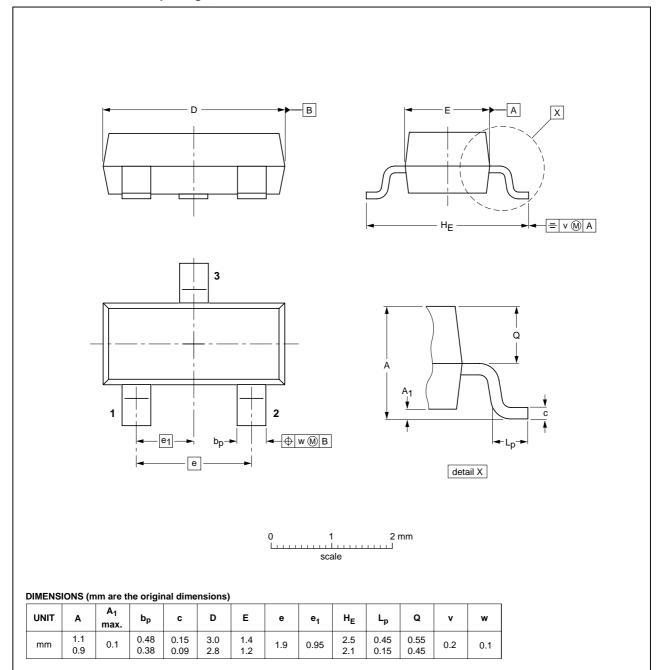
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PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT23



OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT23		TO-236AB				97-02-28 99-09-13	

50 V; 3 A NPN low V_{CEsat} (BISS) transistor

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DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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